

**FEATURES**

- ❑ 4.75V to 5.5V Operating voltage range
- ❑ Power supply ( $V_{DD}$ ) monitor set by the internal voltage reference at 4.65V
- ❑ Precision Input Voltage Monitor using an internal 1.25V voltage reference
- ❑ Watchdog Timer Circuit monitoring activity on WDI input
  - Nominal timeout 1.6s
- ❑  $\overline{\text{RESET}}$  output responding to the  $V_{DD}$  monitor and the manual reset input  $\overline{\text{MR}}$ 
  - Nominal  $\overline{\text{RESET}}$  pulse width 200ms
- ❑  $\overline{\text{RESET}}$  level valid for  $V_{DD} \geq 1.2V$
- ❑ Operating Temperature Range  $-55^{\circ}\text{C}$  to  $+125^{\circ}\text{C}$
- ❑ Low Power, Typical 400uA
- ❑ Operational environment:
  - Total dose: 300 krad(Si)
  - SEL Immune:  $\leq 110 \text{ MeV}\cdot\text{cm}^2/\text{mg}$  @  $125^{\circ}\text{C}$
  - SET Immune:  $\leq 80 \text{ MeV}\cdot\text{cm}^2/\text{mg}$
- ❑ Packaging options:
  - 8-lead dual-in-line flatpack
- ❑ Standard Microelectronics Drawing (SMD) 5962-11213
  - QML Q and V

**INTRODUCTION**

The UT01VS50L's function is to monitor vital supply and signal voltages in microprocessor systems. It provides for safe reset during power up, power down and brownout conditions by using an internal precision voltage reference.

The UT01VS50L monitors activity at an independent watchdog input by employing an internal timer and a watchdog output that goes low if the input is not toggled within 1.6s. It provides for precision voltage threshold detection on an independent voltage input which could be used for battery or supply-low monitoring of a supply voltage other than  $V_{DD}$ .

The UT01VS50L includes an active low manual reset with an internal pull-up.

**APPLICATIONS**

- ❑ Voltage Supervisor function for various systems including microprocessors, microcontrollers, DSPs and FPGAs
- ❑ Critical battery and power supply monitoring
- ❑ Replacement of older discrete solutions to improve reliability, accuracy and reduce complexity of the systems

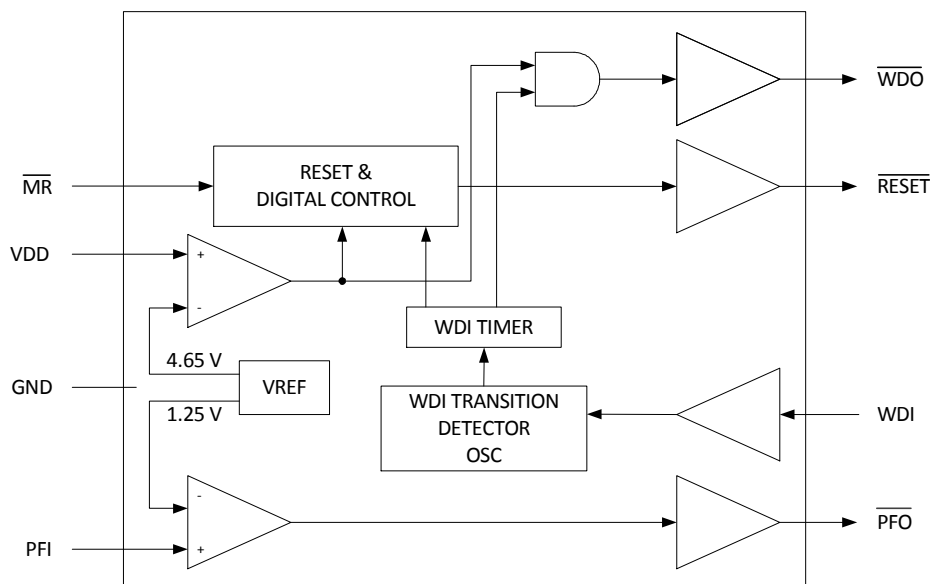
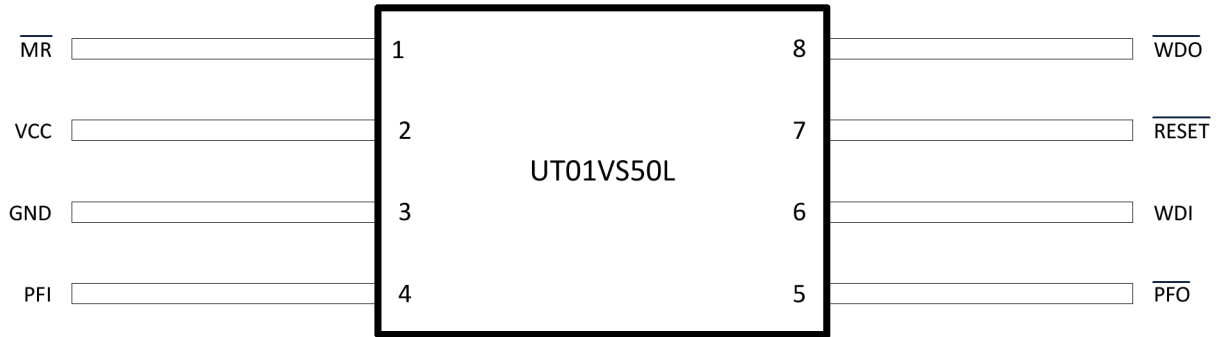


Figure 1. UT01VS50L Functional Block Diagram

## PIN DESCRIPTIONS

Number	Pins	Type	Description
1	$\overline{\text{MR}}$	Digital Input TTL/CMOS compatible	<b>Manual Reset Input with an internal pull-up.</b> Active low. $\overline{\text{MR}}$ low forces the reset output $\overline{\text{RESET}}$ low. Required minimum MR pulse width is 150ns. $\overline{\text{RESET}}$ is held low for duration of the reset timer.
2	VDD	Supply	<b>Power supply.</b> Operating voltage range is 4.75V to 5.5V. $V_{\text{DD}}$ level is monitored internally by a dedicated comparator circuit, which employs an internal bandgap voltage reference nominally equal to 1.25V. Every time $V_{\text{DD}}$ falls below the threshold voltage, nominally 4.65V, $\overline{\text{RESET}}$ and $\overline{\text{WDO}}$ outputs are forced low. (See $\overline{\text{WDO}}$ and $\overline{\text{RESET}}$ descriptions.) (Figure 4.)
3	GND	Supply	<b>ASIC Ground.</b> This pin should be tied to ground and establishes the reference for voltage detection.
4	PFI	Analog Input	<b>Threshold detector input.</b> Voltage on this input is fed directly to an internal comparator where it is compared to the bandgap voltage reference of 1.25V. It can be used for detection of low battery or power failure of voltage supplies other than $V_{\text{DD}}$ . When voltage at PFI input drops below its threshold value of 1.25V, $\overline{\text{PFO}}$ output is forced low, otherwise, stays high.
5	$\overline{\text{PFO}}$	Digital Output	<b>Threshold detector output.</b> Active low, push-pull output driver. It responds directly to PFI input. If PFI voltage is below the bandgap reference voltage, $\overline{\text{PFO}}$ is low. If PFI is above the reference voltage, $\overline{\text{PFO}}$ output is high.
6	WDI	Digital Input	<b>Watchdog timer input pin.</b> This pin is typically used to monitor microprocessor activity. It can assume three states: low, high and float. If WDI is floating or connected to a high impedance three state buffer, the watchdog timer is not active, and the corresponding watchdog output $\overline{\text{WDO}}$ is high. Watchdog timer is also not active any time $\overline{\text{RESET}}$ is low. Providing that $\overline{\text{RESET}}$ is not asserted, any change of state at WDI that is longer than 50ns will start the timer, or restart it, if the timer is already running (Figure 3.). If there is no activity within the timeout period, nominally 1.6sec, the timer will stop running and $\overline{\text{WDO}}$ output will go low (Figure 3).
7	$\overline{\text{RESET}}$	Digital Output	<b>Reset output.</b> Active low, push-pull output driver. This output responds to both: $V_{\text{DD}}$ monitoring circuits and the manual reset input $\overline{\text{MR}}$ . On power up, $\overline{\text{RESET}}$ is guaranteed to be logic low for all $V_{\text{DD}}$ values from 1.2V up to the reset threshold, nominally 4.65V. Once this threshold is reached, an internal $\overline{\text{RESET}}$ timer is activated. During the countdown $\overline{\text{RESET}}$ output is kept low. It is raised high upon completion of countdown, typically after 200ms. If a brown out condition occurs during the reset timer countdown, the reset timer would be reset and another countdown would start after $V_{\text{DD}}$ levels were restored above the reset threshold. On power down, when $V_{\text{DD}}$ falls below the threshold voltage, $\overline{\text{RESET}}$ goes low and is guaranteed to stay low until $V_{\text{DD}}$ drops below 1.2V. If $\overline{\text{MR}}$ is asserted low, $\overline{\text{RESET}}$ is forced low and the reset timer is kept reset. When $\overline{\text{MR}}$ is released high, the timer is activated and $\overline{\text{RESET}}$ is kept low until completion of the reset timeout, when it is raised high.

Number	Pins	Type	Description
8	$\overline{\text{WDO}}$	Digital Output	<p><b>Watchdog output.</b> Active low, push-pull output driver. This pin is usually connected to a non-maskable interrupt input of a microprocessor. On power up, <math>\overline{\text{WDO}}</math> responds to <math>V_{\text{DD}}</math> monitoring circuitry. It stays low until the reset threshold, 4.65V nominally, is reached. At that point, <math>\overline{\text{WDO}}</math> is raised high. The internal watchdog timer is activated after <math>\overline{\text{RESET}}</math> is released. If there is no activity on <math>\overline{\text{WDI}}</math> input, <math>\overline{\text{WDO}}</math> goes low after the watchdog timer times out, which is typically after 1.6sec. Any activity on <math>\overline{\text{WDI}}</math> will force <math>\overline{\text{WDO}}</math> output to go high and the watchdog timer will be activated. If <math>\overline{\text{WDI}}</math> is floating or connected to a high impedance buffer output, the timer is kept in a reset state and <math>\overline{\text{WDO}}</math> stays high. When <math>V_{\text{DD}}</math> drops below 4.65V, <math>\overline{\text{WDO}}</math> goes low regardless of whether the watchdog timer has timed out or not. <math>\overline{\text{RESET}}</math> goes low simultaneously which prevents an interrupt.</p> <p>If <math>\overline{\text{WDI}}</math> input is left unconnected, <math>\overline{\text{WDO}}</math> can be used as a low line output. Since a floating <math>\overline{\text{WDI}}</math> disables the internal watchdog timer, <math>\overline{\text{WDO}}</math> goes low when <math>V_{\text{DD}}</math> drops below 4.65V, thus, functioning as a low line output. (Figure 4.)</p>



**Figure 2. UT01VS50L Pin Configuration**

**OPERATIONAL ENVIRONMENT**

PARAMETER	LIMIT	UNITS
Total Ionizing Dose (TID)	300	krad(Si)
Single Event Latchup Immune (SEL)	≤110	MeV-cm <sup>2</sup> /mg
Single Event Transient Immune (SET)	≤80	MeV-cm <sup>2</sup> /mg

**ABSOLUTE MAXIMUM RATINGS**<sup>1</sup>

(Referenced to GND)

SYMBOL	PARAMETER	LIMITS	UNITS
V <sub>DD</sub>	Voltage supply	7.2	V
T <sub>J</sub>	Maximum junction temperature	175	°C
T	Storage temperature	-65 to +150	°C
P <sub>D</sub>	Power dissipation	2.5	W
V <sub>in</sub>	Input voltages	-0.3V to (V <sub>DD</sub> +0.3V)	V
T <sub>lead</sub>	Lead Temperature (soldering, 10 seconds)	+300	°C
Θ <sub>JC</sub>	Thermal resistance, junction-to-case	15	°C/W
V <sub>ESD</sub>	ESD <sub>HBM</sub>	1000	V

**Notes:**

1. Stresses outside the listed absolute maximum ratings may cause permanent damage to the device. This is a stress rating only, and functional operation of the device at these or any other conditions beyond limits indicated in the operational sections of this specification is not recommended. Exposure to absolute maximum rating conditions for extended periods may affect device reliability.

**RECOMMENDED OPERATING CONDITIONS**

SYMBOL	PARAMETER	LIMITS	UNITS
V <sub>DD</sub>	Positive supply voltage	4.75 to 5.5	V
T <sub>C</sub>	Case temperature range	-55 to +125	°C
GND	Negative supply voltage	0.0	V

**ELECTRICAL CHARACTERISTICS** <sup>1,2</sup>  
(V<sub>DD</sub> = 4.75V to 5.5V; -55°C ≤ T<sub>C</sub> ≤ +125°C)

SYMBOL	PARAMETER	CONDITION	MIN	MAX	UNIT
<b>Power Supply</b>					
I <sub>DD</sub>	V <sub>DD</sub> supply current	V <sub>DD</sub> =5.5V		530	μA
<b>Digital Inputs and Outputs (MR, RESET, WDI, WDO, PFO)</b>					
V <sub>IL</sub>	Digital input low	V <sub>DD</sub> =4.75V		0.8	V
V <sub>IH</sub>	Digital input high	V <sub>DD</sub> =5.5V	3.5		V
V <sub>IL</sub> $\overline{\text{MR}}$	Manual reset input low	V <sub>DD</sub> =4.75V		0.8	V
V <sub>IH</sub> $\overline{\text{MR}}$	Manual reset input high	V <sub>DD</sub> =5.5V	2.0		V
V <sub>OL</sub> <sup>3</sup>	Digital output low	V <sub>DD</sub> =4.75V, I <sub>OL</sub> =3.2mA		0.4	V
V <sub>OH</sub> <sup>3</sup>	Digital output high	V <sub>DD</sub> =4.75V, I <sub>OH</sub> =800μA	V <sub>DD</sub> - 1.5		V
<b>Timing and Threshold Voltages</b>					
t <sub>RST-ASSRT</sub> <sup>4</sup>	V <sub>DD</sub> falling reset assertion	V <sub>DD</sub> < 4.5V	0.2	0.8	μs
t <sub>RS</sub>	Reset pulse width	V <sub>DD</sub> =4.75V	140	280	ms
t <sub>WD</sub>	Watchdog time-out period	V <sub>DD</sub> =5.5V	1.0	2.25	s
t <sub>WP</sub>	Watchdog input pulse width	V <sub>DD</sub> =4.75V, V <sub>IL</sub> = 0.4V, V <sub>IH</sub> =0.8XV <sub>DD</sub>	50		ns
V <sub>RT</sub>	Reset threshold voltage		4.5	4.75	V
V <sub>RTHYS</sub>	Reset threshold voltage hysteresis		20		mV
t <sub><math>\overline{\text{MR}}</math></sub>	Manual reset ( $\overline{\text{MR}}$ ) input pulse width	V <sub>DD</sub> =4.75V	150		ns
t <sub>MD</sub>	Manual reset ( $\overline{\text{MR}}$ ) to reset out delay	V <sub>DD</sub> =4.75V		100	ns
<b>Analog Input PFI</b>					
I <sub>PFI</sub> <sup>4</sup>	Threshold detector input (PFI) current	V <sub>DD</sub> =5.5V	-20	20	nA
V <sub>PFI</sub>	Threshold detector input (PFI) threshold voltage	V <sub>DD</sub> =5.0V	1.20	1.30	V
I <sub><math>\overline{\text{MR}}</math></sub>	Manual reset pull-up current	V <sub>DD</sub> =5.5V, $\overline{\text{MR}}$ =0.0V	-500	-100	μA
I <sub>WDI</sub>	Watchdog input (WDI) current	WDI pin = V <sub>DD</sub> = 5.5V WDI pin = 0V; V <sub>DD</sub> = 5.5V	-35	35	μA μA
t <sub>RPFI</sub>	PFI rising threshold crossing to PFO delay			15	μs
t <sub>FPFI</sub>	PFI falling threshold crossing to PFO delay			35	μs

**Notes:**

1. For devices procured with a total ionizing dose tolerance guarantee, the post-irradiation performance at 25°C per MIL-STD-883 Method 1019, Condition A, up to the maximum TID level procured (see ordering information).
2. Unless otherwise specified,  $V_{DD} = 4.75V$  to  $5.5V$ ,  $-55^{\circ}C \leq T_C \leq +125^{\circ}C$ .  $\overline{RESET}$  is the only parameter operable within 1.2V and the minimum recommended operating supply voltage.
3.  $V_{OL}$ ,  $V_{OH}$  characteristics apply to  $\overline{WDO}$ ,  $\overline{PFO}$  and  $\overline{RESET}$
4. Guaranteed by design, but not tested.

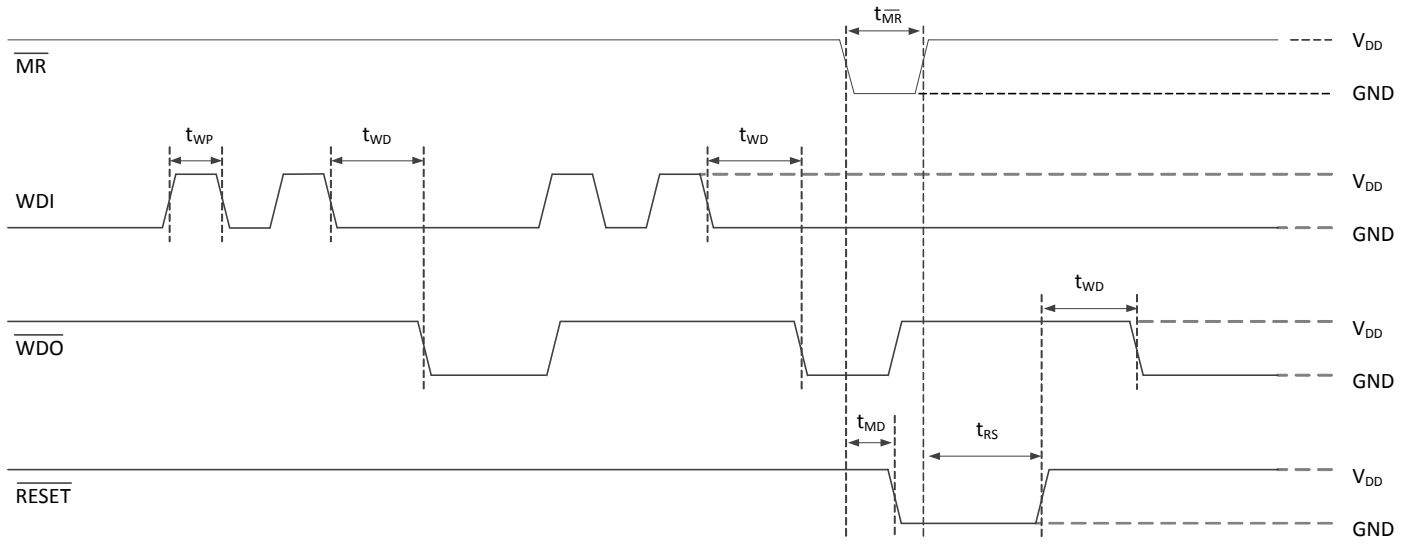


Figure 3. WDI and  $\overline{\text{WDO}}$  timing waveforms. Reset externally triggered by  $\overline{\text{MR}}$ .

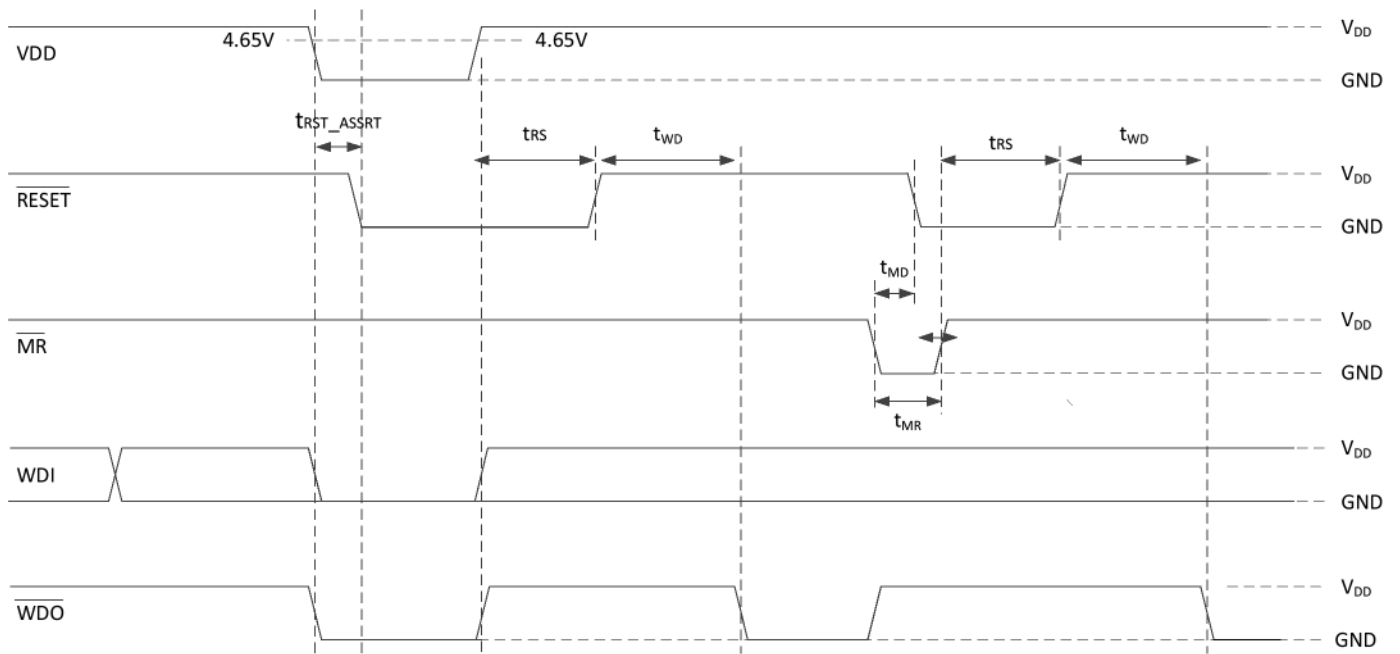
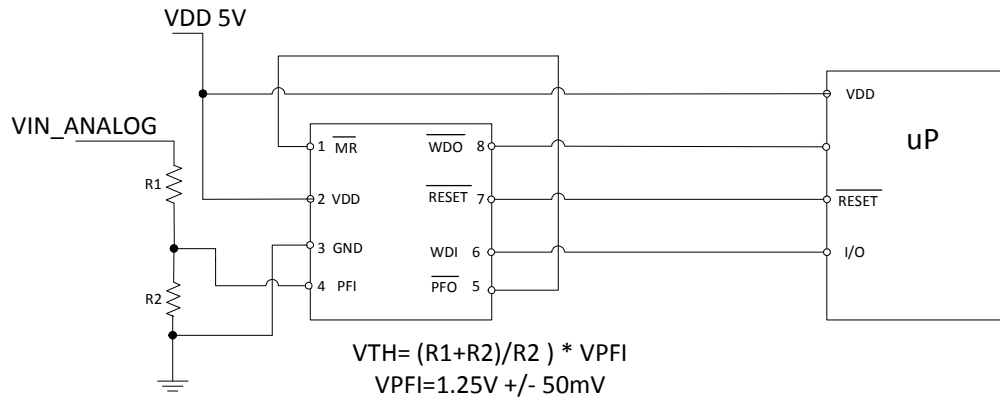
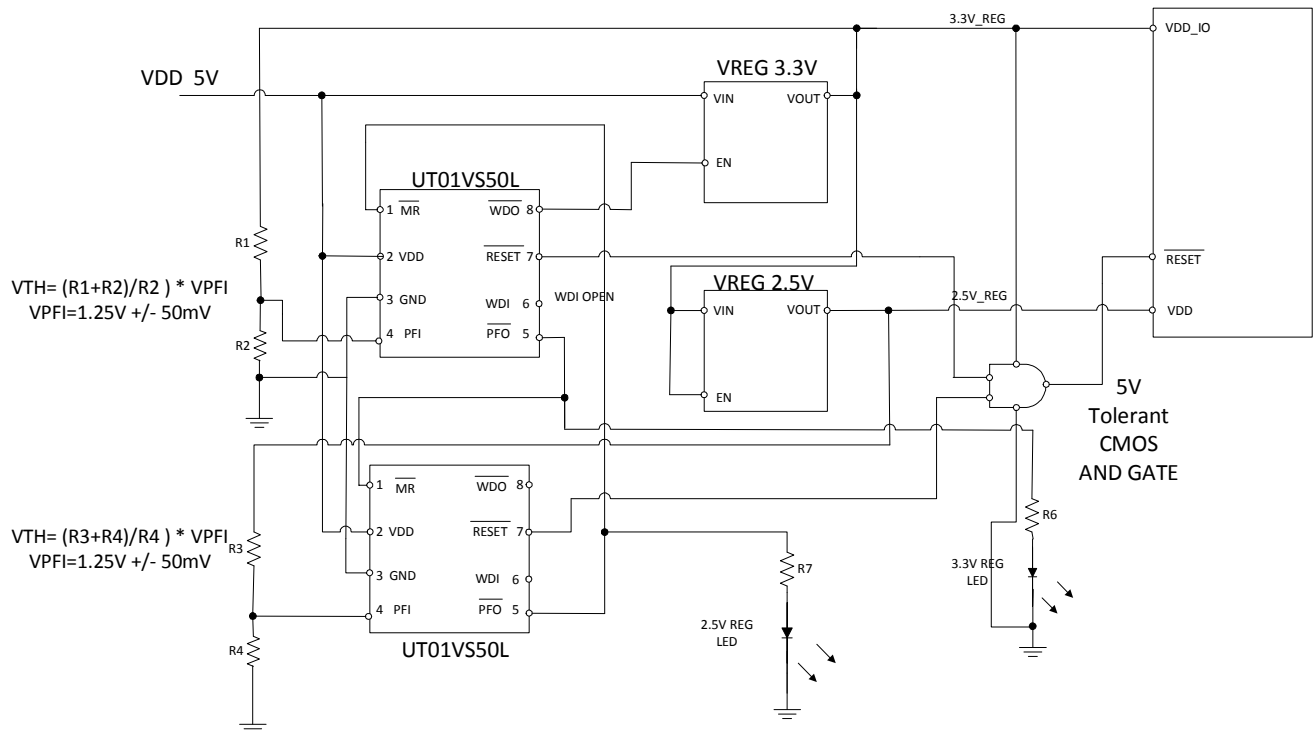


Figure 4.  $\overline{\text{RESET}}$  and  $\overline{\text{WDO}}$  are driven low for  $V_{DD} < 4.65$  volts.  $\overline{\text{WDO}}$  is driven high when  $\overline{\text{MR}}$  is low.



**Figure 5. UT01VS50L Under Voltage Monitor and Detection**

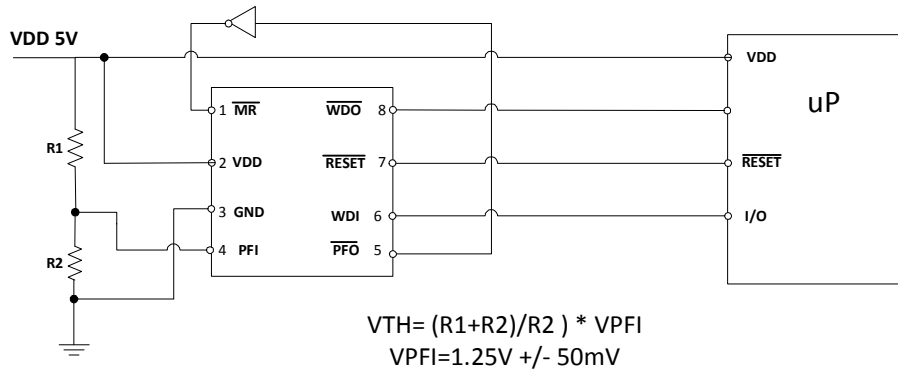
Shown in Figure 5 is an application for monitoring the under voltage of a power supply connected to a microprocessor or ASIC. If the analog voltage monitored falls below the desired threshold value, the PFO output connected to the MR input will transition low causing the RESET output to be asserted low indicating an under voltage condition.



**Figure 6. Under Voltage Monitoring and sequencing of 3.3V and 2.5V Power Supplies**

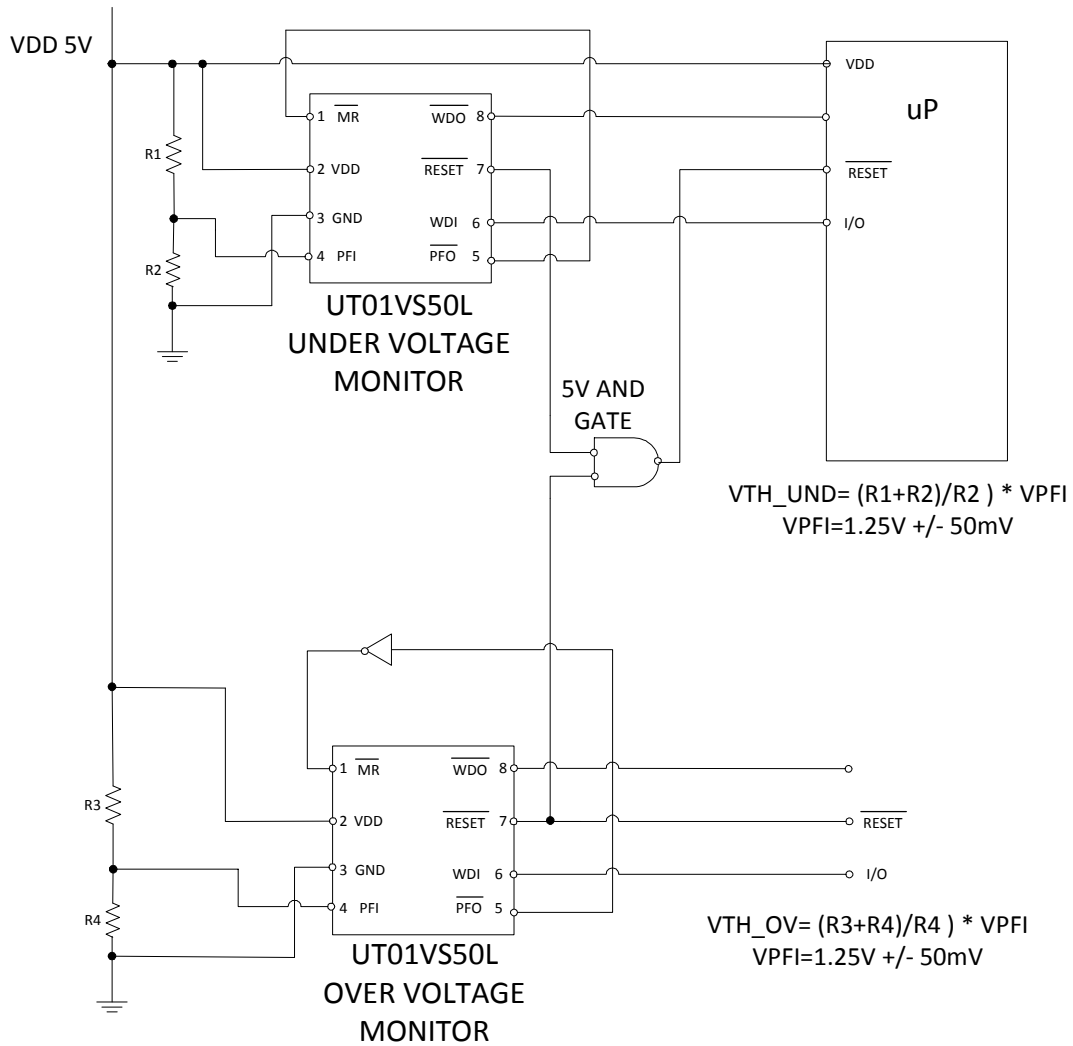
Shown in Figure 6 are two Voltage Supervisors configured to monitor both the 3.3V and 2.5V power supplies of a system. The 3.3V regulated supply is monitored by the PFI pin of the top Voltage Supervisor, while the 2.5 V regulated supply is monitored by the PFI





**Figure 7. UT01VS50L Over Voltage Power Supply Monitoring and Reset**

Shown in Figure 7 is an application to monitor and detect power supply over voltage through the use of the PFI pin. When the voltage at the PFI input, ( $V_{TH}$ ) exceeds  $V_{REF}$ , (1.2 to 1.3V) the  $\overline{PFO}$  output transitions from low to high causing the  $\overline{MR}$  output to transition from high to low. This asserts a  $\overline{RESET}$  indicating the voltage being monitored has exceeded the over voltage monitor limit.



**Figure 8. UT01VS50L Over Voltage Power Supply Monitoring and Reset**

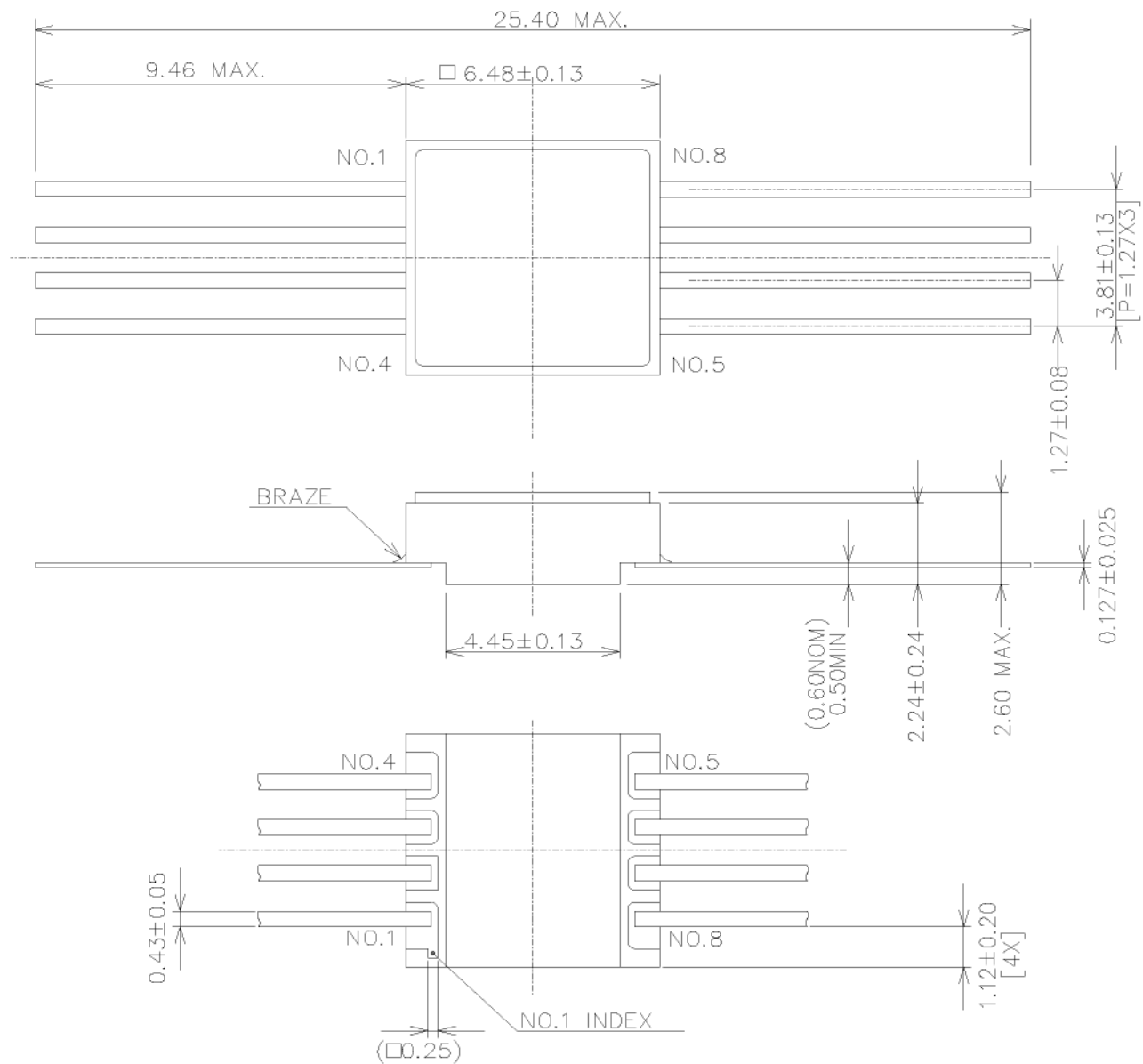
Shown in Figure 8 is an application using two UT01VS50L Voltage Supervisors to monitor both under voltage and over voltage of a power supply. In this application the top Voltage Supervisor monitors the under-voltage of a 5V power supply while the bottom Voltage Supervisor monitors the over voltage of the same 5V power supply.

The 5V supply is monitored through the PFI input of both Voltage Supervisors. Resistor values for both under voltage and over voltage monitoring can be set to accommodate a range of power supply voltages.

During normal operation where VDD is within the allowed range ( $V_{DD\_UND} < V_{DD} < V_{DD\_OV}$ ),  $\overline{RESET}$  of both Voltage Supervisors will be at logic high level. The Table 1 below shows the truth table for functional, under voltage detection and over voltage detection.

**Table 1. Under Voltage Over Voltage Truth Table**

<b>VDD</b>	<b>PFO_UND</b>	<b>PFO_OV</b>	<b>RESET_UND</b>	<b>RESET_OV</b>	<b>RESET</b>	<b>uP or ASIC Mode</b>
Normal Operation	HIGH	LOW	HIGH	HIGH	HIGH	Normal
VDD < VDD_UND	LOW	LOW	LOW	HIGH	LOW	Reset Asserted
VDD > VDD_OV	HIGH	HIGH	HIGH	LOW	LOW	Reset Asserted



NOTES:

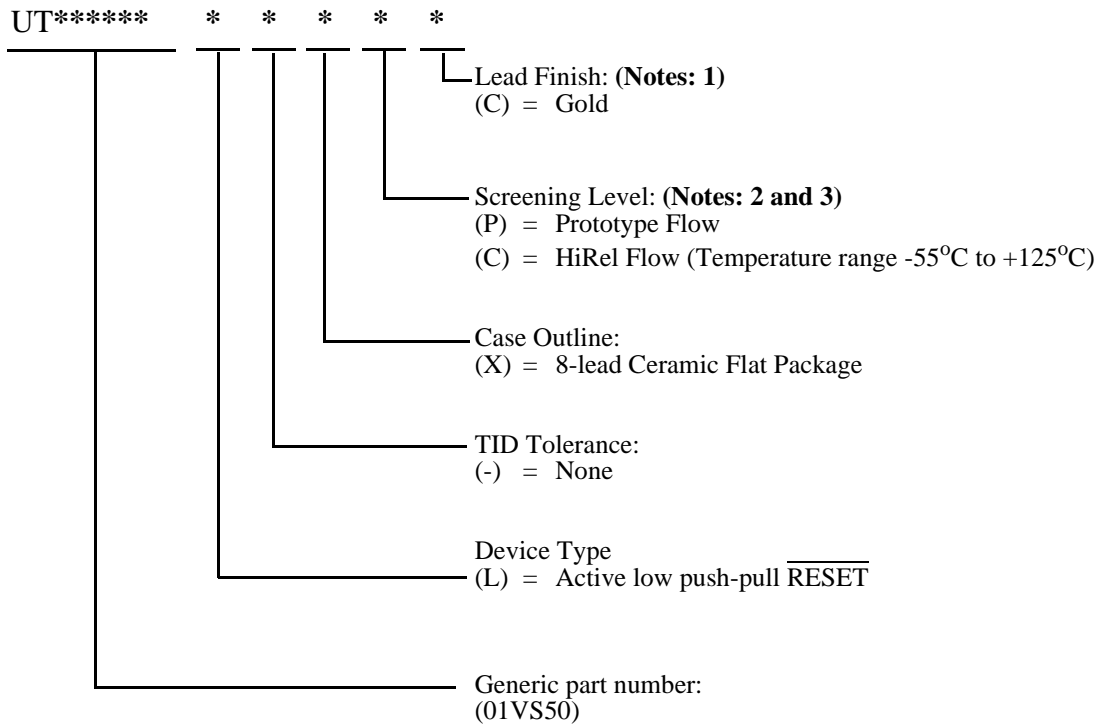
1. PACKAGE MATERIAL: OPAQUE 90% MINIMUM ALUMINA CERAMIC.
2. ALL EXPOSED METAL AREAS MUST BE GOLD PLATED 100 TO 225 MICRONS THICK OVER ELECTROPLATED NICKEL UNDERCOATING 100 TO 350 MICRONS THICK PER MIL-PRF-38535.
3. THE SEAL RING IS ELECTRICALLY CONNECTED TO VSS.

44338

Figure 5. 8-pin Dual-In-Line Flatpack

## ORDERING INFORMATION

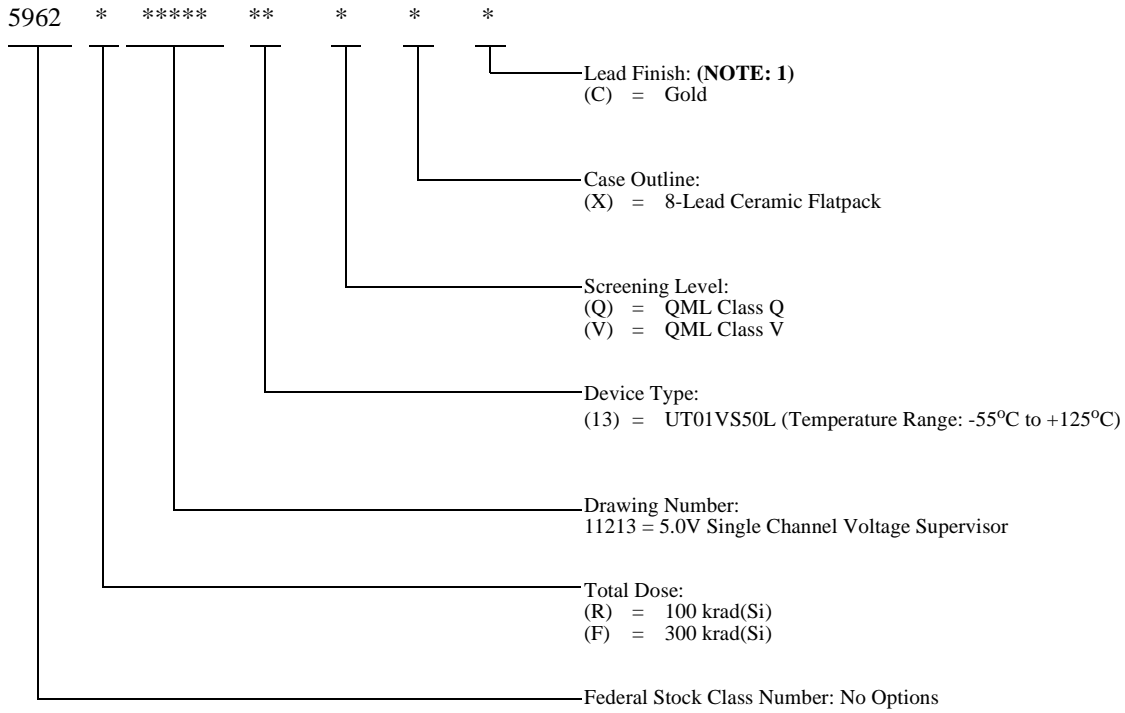
### UT01VS50L VOLTAGE SUPERVISOR



#### Notes:

1. Lead finish is "C" (Gold) only.
2. Prototype flow per Aeroflex Manufacturing Flows Document. Devices are tested at 25°C only. Radiation neither tested nor guaranteed.
3. HiRel Flow per Aeroflex Manufacturing Flows Document. Radiation neither tested nor guaranteed.

# UT01VS50L VOLTAGE SUPERVISOR SMD



Notes:

1. Lead finish is "C" (gold) only.

***Cobham Semiconductor Solutions - Datasheet Definition***

**Advanced Datasheet - Product In Development**

**Preliminary Datasheet - Shipping Prototype**

**Datasheet - Shipping QML & Reduced Hi-Rel**

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## DATA SHEET REVISION HISTORY

<b>REV</b>	<b>Revision Date</b>	<b>Description of Change</b>	<b>Author</b>
1	12-16	Cobham Datasheet format added along with edit to SMD Ordering on Device Type and Gold Finish.	RL